

## High Performance Schottky Rectifier, 1 A


**SMB**

**FEATURES**

- Small foot print, surface mountable
- Low forward voltage drop
- High frequency operation
- Guard ring for enhanced ruggedness and long term reliability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)
- Designed and qualified for industrial level


**RoHS**  
 COMPLIANT

PRODUCT SUMMARY	
Package	SMB
$I_{F(AV)}$	1.0 A
$V_R$	100 V
$V_F$ at $I_F$	0.78 V
$I_{RM}$	1 mA at 125 °C
$T_J$ max.	175 °C
Diode variation	Single die
$E_{AS}$	1.0 mJ

**DESCRIPTION**

The VS-10BQ100PbF surface mount Schottky rectifier has been designed for applications requiring low forward drop and very small foot prints on PC boards. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS			
SYMBOL	CHARACTERISTICS	VALUES	UNITS
$I_{F(AV)}$	Rectangular waveform	1.0	A
$V_{RRM}$		100	V
$I_{FSM}$	$t_p = 5 \mu s$ sine	780	A
$V_F$	1.0 A <sub>pk</sub> , $T_J = 125 \text{ °C}$	0.62	V
$T_J$	Range	-55 to +175	°C

VOLTAGE RATINGS			
PARAMETER	SYMBOL	VS-10BQ100PbF	UNITS
Maximum DC reverse voltage	$V_R$	100	V
Maximum working peak reverse voltage	$V_{RWM}$		

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum average forward current	$I_{F(AV)}$	50 % duty cycle at $T_L = 152 \text{ °C}$ , rectangular waveform	1.0	A
Maximum peak one cycle non-repetitive surge current	$I_{FSM}$	5 $\mu s$ sine or 3 $\mu s$ rect. pulse	Following any rated load condition and with rated $V_{RRM}$ applied	780
		10 ms sine or 6 ms rect. pulse		38
Non-repetitive avalanche energy	$E_{AS}$	$T_J = 25 \text{ °C}$ , $I_{AS} = 0.5 \text{ A}$ , $L = 8 \text{ mH}$	1.0	mJ
Repetitive avalanche current	$I_{AR}$	Current decaying linearly to zero in 1 $\mu s$ Frequency limited by $T_J$ maximum $V_A = 1.5 \times V_R$ typical	0.5	A

ELECTRICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum forward voltage drop See fig. 1	$V_{FM}^{(1)}$	1 A	$T_J = 25\text{ }^\circ\text{C}$	0.78	V
		2 A		0.89	
		1 A	$T_J = 125\text{ }^\circ\text{C}$	0.62	
		2 A		0.72	
Maximum reverse leakage current See fig. 2	$I_{RM}^{(1)}$	$T_J = 25\text{ }^\circ\text{C}$	$V_R = \text{Rated } V_R$	0.5	mA
		$T_J = 125\text{ }^\circ\text{C}$		1	
Typical junction capacitance	$C_T$	$V_R = 5\text{ }V_{DC}$ , (test signal range 100 kHz to 1 MHz), $25\text{ }^\circ\text{C}$	42	pF	
Typical series inductance	$L_S$	Measured lead to lead 5 mm from package body	2.0	nH	
Maximum voltage rate of charge	dV/dt	Rated $V_R$	10 000	V/ $\mu\text{s}$	

**Note**

(1) Pulse width < 300  $\mu\text{s}$ , duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum junction and storage temperature range	$T_J^{(1)}, T_{Stg}$		-55 to +175	$^\circ\text{C}$
Maximum thermal resistance, junction to lead	$R_{thJL}^{(2)}$	DC operation	36	$^\circ\text{C/W}$
Maximum thermal resistance, junction to ambient	$R_{thJA}$		80	
Approximate weight			0.10	g
			0.003	oz.
Marking device		Case style SMB (similar DO-214AA)	V1J	

**Notes**

(1)  $\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$  thermal runaway condition for a diode on its own heatsink

(2) Mounted 1" square PCB

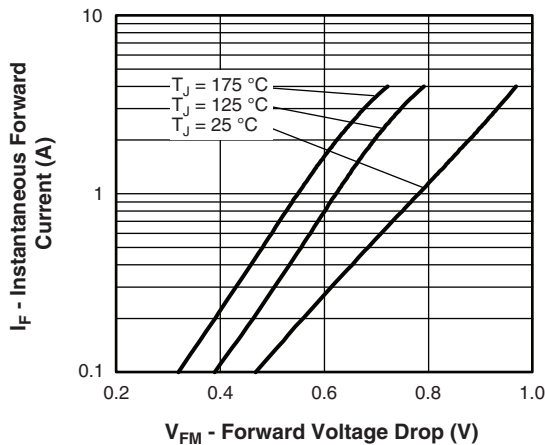


Fig. 1 - Maximum Forward Voltage Drop Characteristics

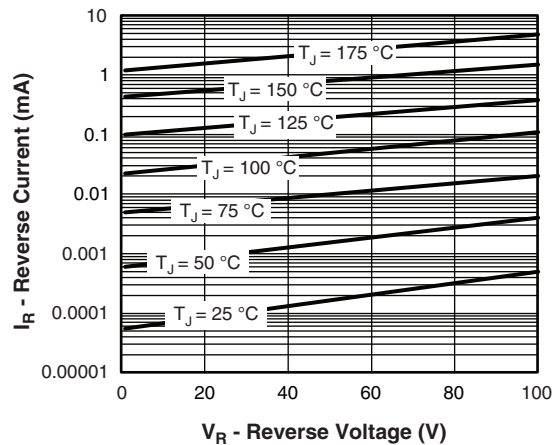


Fig. 2 - Typical Peak Reverse Current vs. Reverse Voltage

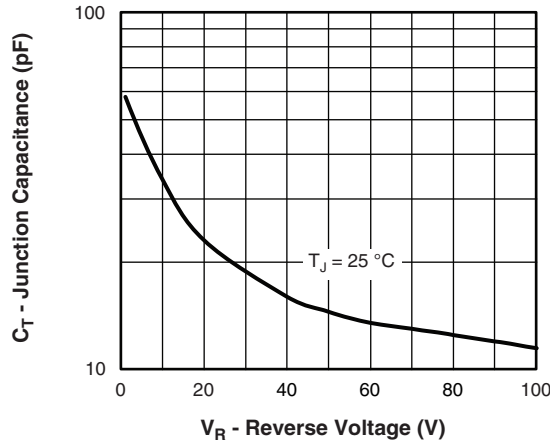


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

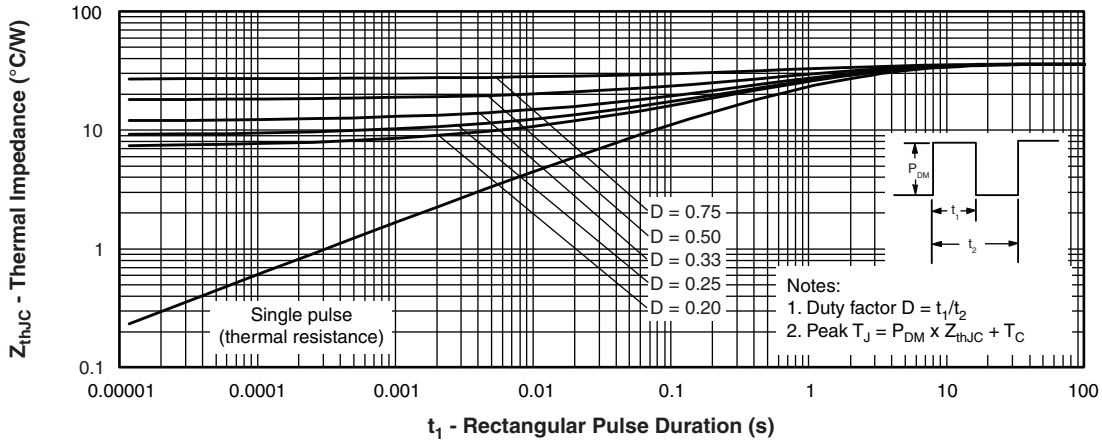


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (Per Leg)

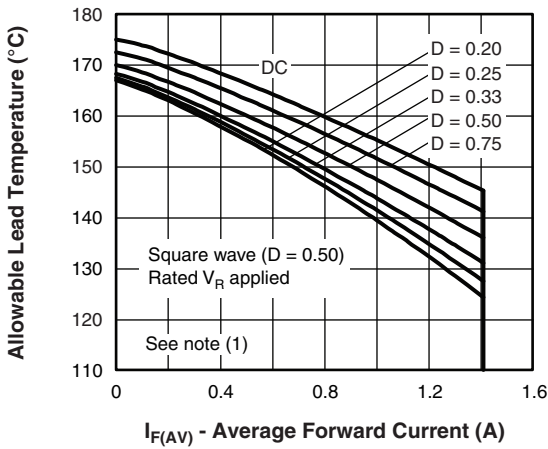


Fig. 5 - Maximum Average Forward Current vs. Allowable Lead Temperature

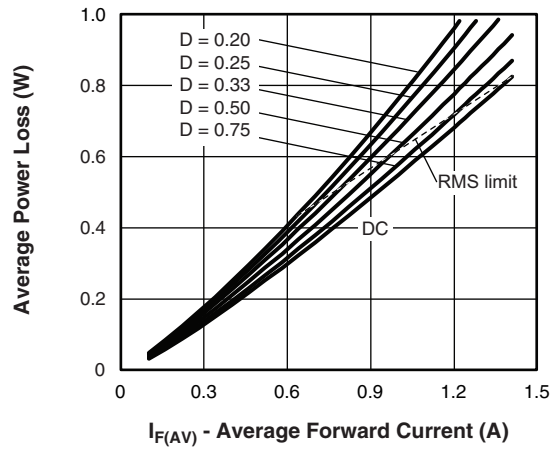


Fig. 6 - Maximum Average Forward Dissipation vs. Average Forward Current

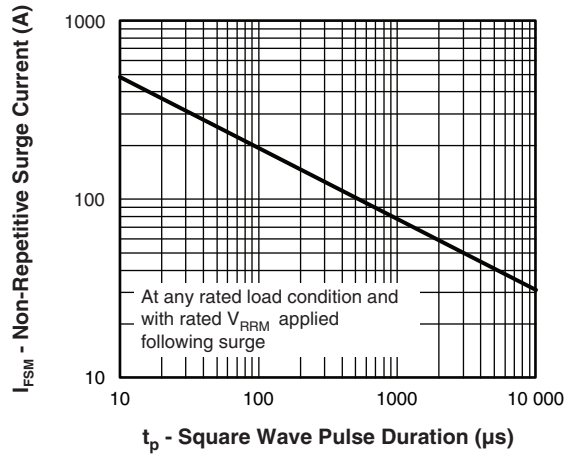


Fig. 7 - Maximum Peak Surge Forward Current vs. Pulse Duration

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{d_{REV}}) \times R_{thJC}$ ;
- $P_d$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);
- $P_{d_{REV}}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1} = 80\%$  rated  $V_R$

**ORDERING INFORMATION TABLE**

Device code	<b>VS-</b>	<b>10</b>	<b>B</b>	<b>Q</b>	<b>100</b>	<b>TR</b>	<b>PbF</b>
	①	②	③	④	⑤	⑥	⑦

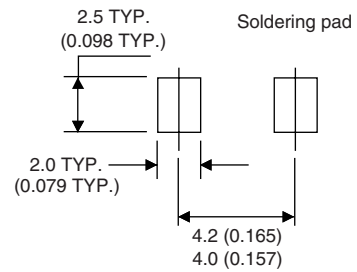
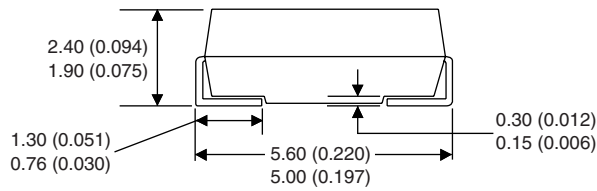
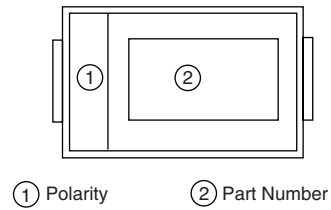
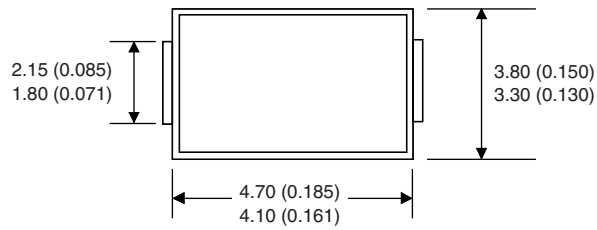
  

<b>1</b>	- Vishay Semiconductors product
<b>2</b>	- Current rating
<b>3</b>	- B = single lead diode
<b>4</b>	- Q = Schottky "Q" series
<b>5</b>	- Voltage rating (100 = 100 V)
<b>6</b>	- • None = box (1000 pieces) • TR = tape and reel (3000 pieces)
<b>7</b>	- PbF = lead (Pb)-free

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95017">www.vishay.com/doc?95017</a>
Part marking information	<a href="http://www.vishay.com/doc?95029">www.vishay.com/doc?95029</a>
Packaging information	Tape and reel <a href="http://www.vishay.com/doc?95034">www.vishay.com/doc?95034</a>
	Bulk <a href="http://www.vishay.com/doc?95397">www.vishay.com/doc?95397</a>
SPICE model	<a href="http://www.vishay.com/doc?95276">www.vishay.com/doc?95276</a>

## SMB

**DIMENSIONS** in millimeters (inches)





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